

# Avalanche Diodes (APD) Detectors: Introduction and Recent Advances\*

Alfred Q.R. Baron

Harima RIKEN & SPring-8/JASRI

International Symposium on the Development of Detectors  
for Particle, Astro-Particle, and Synchrotron Radiation Experiments

"SNIC"

SLAC, Stanford, April 2006

\*Focus on Fast X-Ray Detection

# A Change in Scale...

Compared to the detector effort in high-energy physics, the effort in synchrotron radiation is in its childhood,

... and the APD effort in x-ray scattering is nearly a newborn.

Small efforts: ESRF, BNL, DESY, SPring-8, KEK, (SSRL)  
& the recent addition of a dedicated technician  
at ESRF is already a major jump.

# Historical

Development in the 60s & 70s

(Huth, McIntyre, Webb, Jones at GE & RCA)

Some discussion of a "Solid State Photomultiplier"

(but gain not so high...)

Main utility is high speed (large gain-bandwidth product).

Optical Communication, Laser range-finding...

& Applications where for some reason a PMT is not suitable

Positron Emission Tomography (High Magnetic Field)

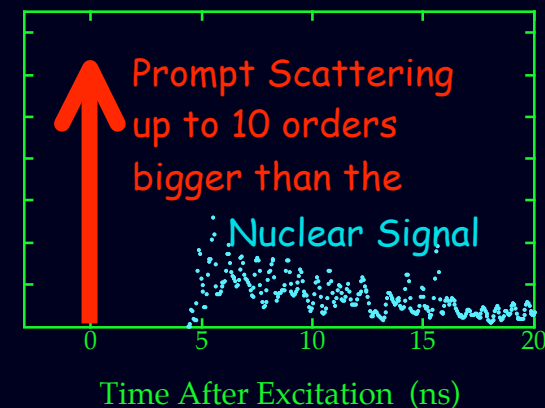
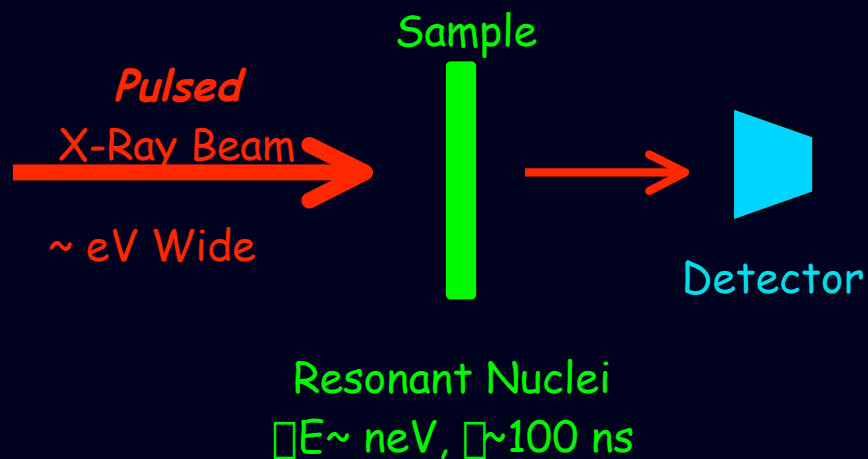
Introduced to the x-ray scattering community via

**Nuclear Resonant Scattering (NRS)  
of Synchrotron Radiation**

1990's



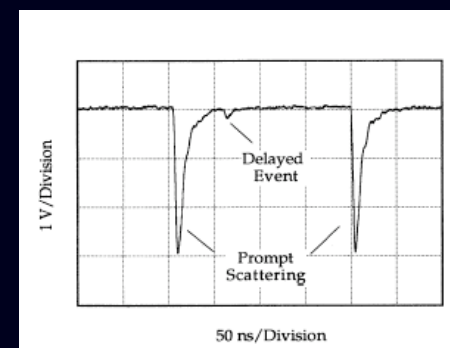
# Nuclear Resonant Scattering (NRS)



Carefully Choose the Sample (Gerdau, Ruffer)

Build the Right Optics (Faigel, Siddons, Hastings)

Use the Right Detector (Kishimoto, Baron)



(1995)

Continues to provide a challenge for detectors...



# APD Research Applications

Fast photon counting:  
*Diffraction, Imaging*      1 MHz Easy,  
 ~100 MHz Possible

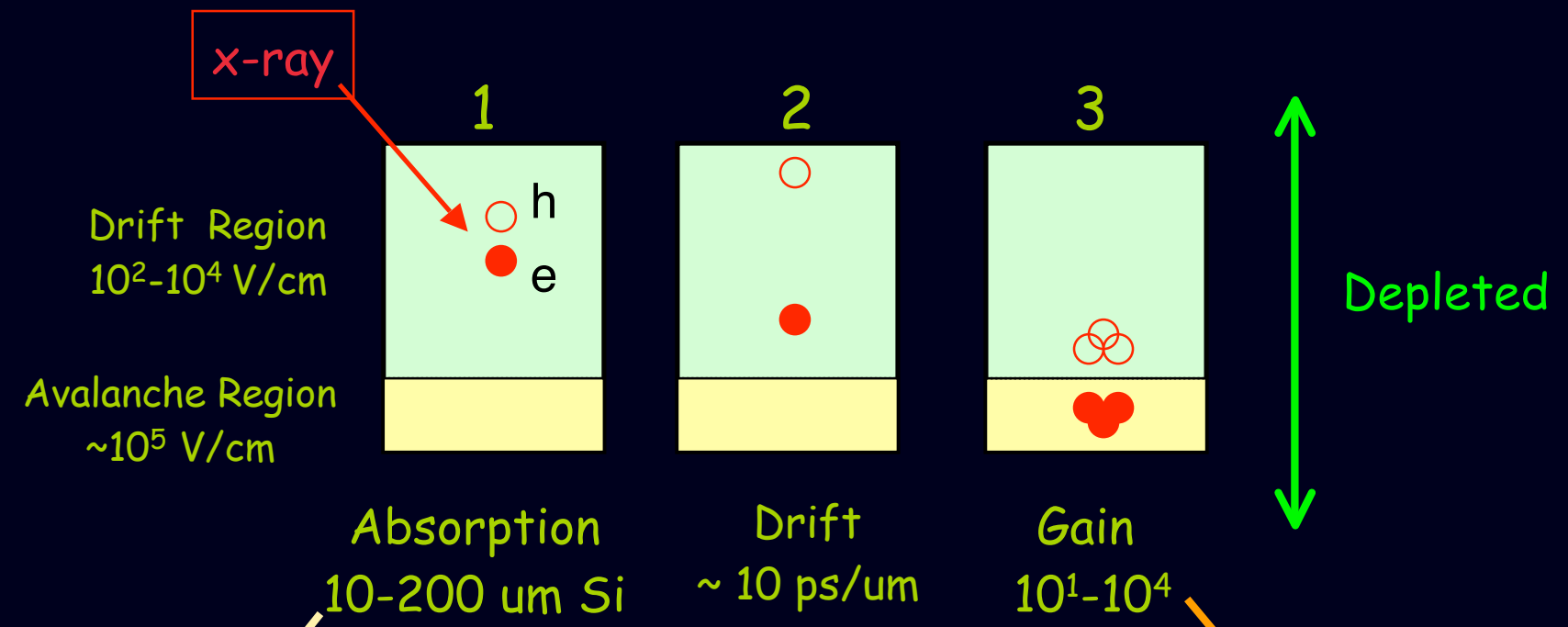
Time resolved detection:  
*NRS, XIFS*      ~1 ns Easy  
 ~0.1 ns Possible

Places where a PMT is not possible...

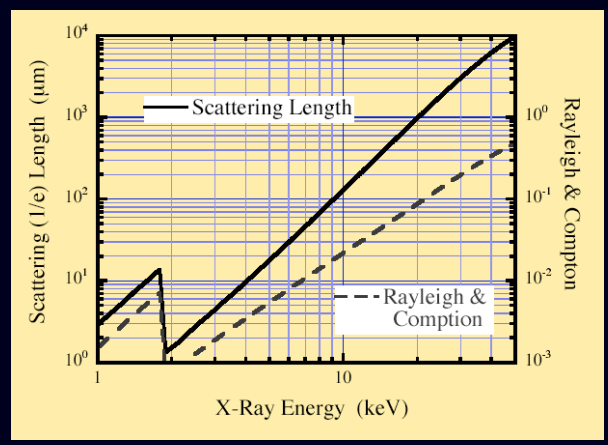
- Magnetic Fields
- Size Constraints
- Power Requirements

Note one large application ( $>10^5$  devices) is for the CMS Calorimeter for scintillator readout in a 4T field (Dieters, Renker)

# A Diode With Gain



Limited Stopping Power  
10 keV X-Rays  $\rightarrow$  OK  
20 keV  $\rightarrow$  Losses



$\sim 50$  Typical  
Intrinsic (excess) noise due to amplification of BOTH Electrons & Holes  
"McIntyre" Theory ( $\sim 1970$ )



# Geiger vs Linear Operation

Linear Operation:

Diode biased below breakdown.  
Well defined small-signal gain.

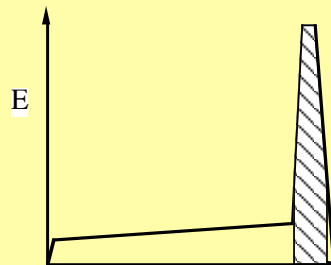
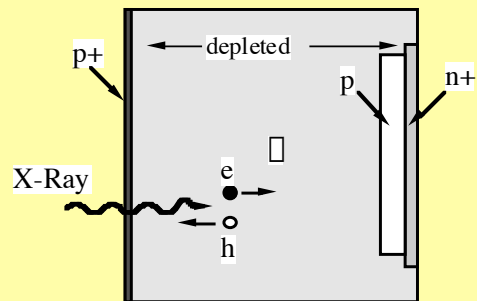
Geiger Operation:

Diode biased above breakdown.  
Single electron leads to run-away  
gain until quenched.  
Noisy:  $10^2$ - $10^5$  cps/channel

(also Poster/Abs 143, Renker)

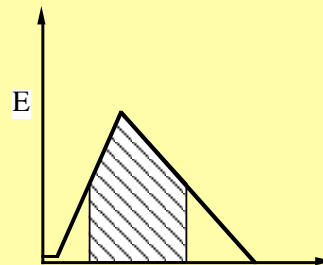
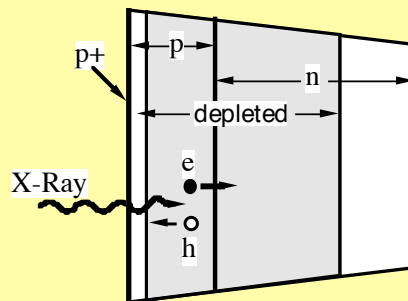
# Structures

"Reach Through"



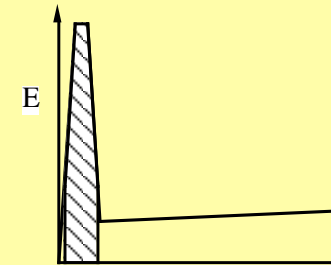
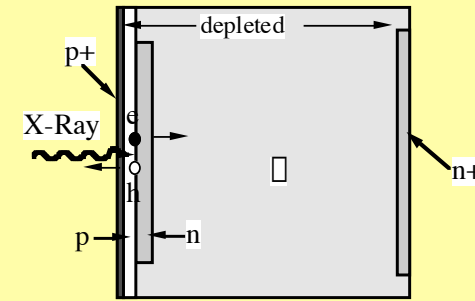
Narrow Gain Region  
 Medium Voltage 50-700V  
 Large Drift Region  
 Modest Gains (<200)  
 Also one-sided epitaxial  
 & diffused & back entry...

"Beveled Edge"



Wide Gain Region  
 High Voltage (1-2 kV)  
 High Gains Possible  
 Larger Areas Possible  
 Also "Planar"

"Reverse"



Narrow Gain Region  
 Medium Voltage <500V  
 Small Drift Region  
 Modest Gains (<200)

# Some Single-Element Devices

Company	Model	Size	Operating Voltage	Active Thickness ( $\mu\text{m}$ )	Capacitance $\text{pF}/\text{mm}^2$ (a)	Gain (a)	Time Resolution FWHM / Tail (ns)	
Perkin-Elmer (PKI /EG&G)	C30626	5x5 mm <sup>2</sup> & smaller	300-400	~110	1.2	50-150	~ 1 / 3	Reliable
	C30703	10x10 mm <sup>2</sup>	350-450	~110	1.2	50-150	~1 / 4	
	Prototype (b)	10x10 mm <sup>2</sup> :	350-450	~180	< 1	50-150	1.7 / 7	
	C30719 (b) Reverse	5x5 mm <sup>2</sup>	350-450	< 10	-	~50	0.17 / 2-3 (c)	
Hamamatsu	SPL2625 (b)	$\phi$ 3 mm 3x5 mm <sup>2</sup>	500-700	~ 130	~1	30-50	1.3 / 3	Mostly Reliable
	S238X	$\phi$ 0.2 to 5 mm	~150	~ 30	6	50-100	0.3 / 5 (c)	
	S534X	$\phi$ 1, 35 mm	~150	~ 10	16	~50	~0.08 / <2	
	S534X LC (b)	$\phi$ 1, 3, 5 mm	~250	~ 20	5	~50	~0.15 / <2	
	S8644-XXK Reverse	$\phi$ 0.2 to 5 mm & 5x5 mm <sup>2</sup> &10x10 mm <sup>2</sup>	~400	~ 7	3	~50	~0.25 / <2	
Advanced Photonix, Inc. (API)	LAAPD Beveled Edge	$\phi$ 3 to 16 mm	~2000	30-50	~1	~200	~0.4 / >5 (c)	Not So Reliable*
Radiation Monitoring Devices (RMD)	S0814	8x8 mm <sup>2</sup>	~1700	30-50	~1?	300-2000	~0.4 / >10 (c)	Not So Reliable*
	S1315 Beveled Edge	13x13 mm <sup>2</sup>						

Note: (1) Not extremely careful conditions.

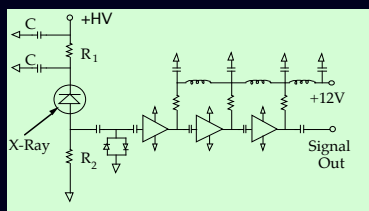
\* As of ~1998

(2) Device Dependence.

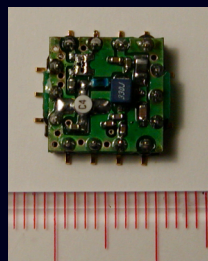
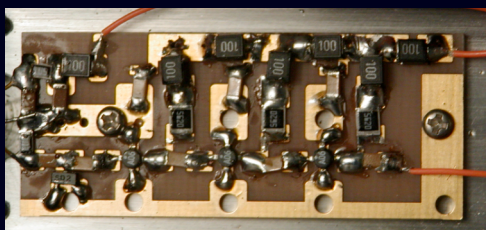
(3) CMS expects >99% reliability (after selection) for 10 years

# Electronics

## ➤ Photon (Pulse) Counting & Timing



Not YET integrated... SM Technology & Modular (NIM) electronics



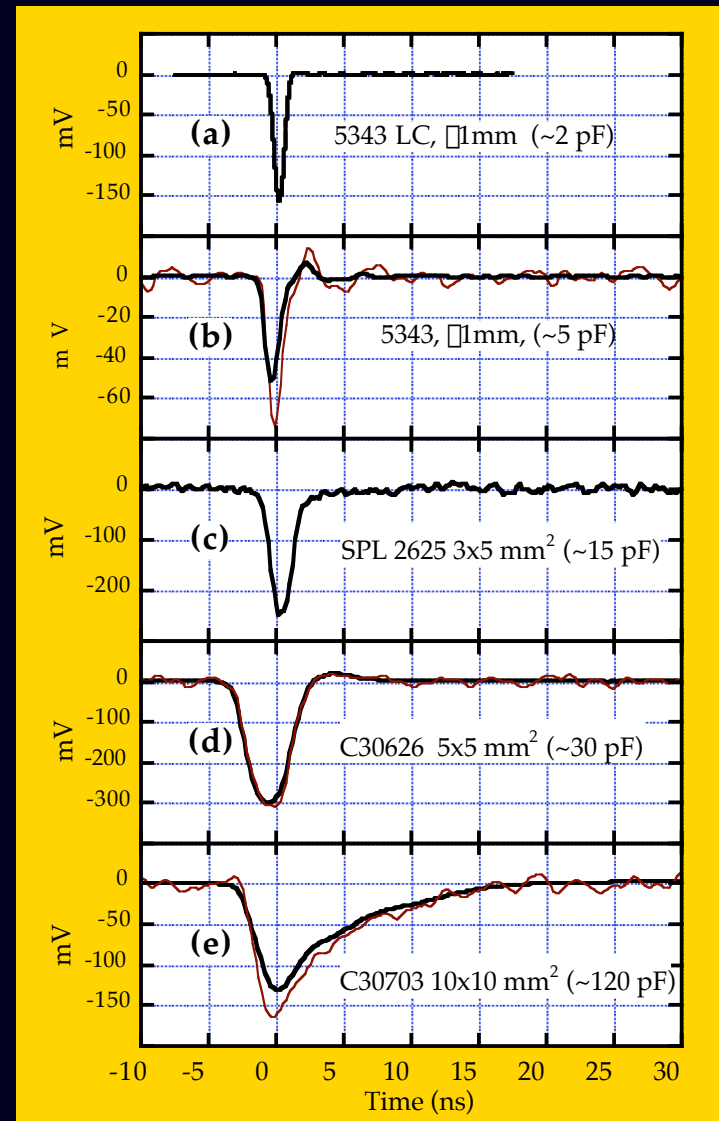
ASIC?

# Typical Scope Traces

Leading edge (rise time) is governed by carrier transport in the device

Trailing edge by diode capacitance and amplifier impedance

Best case ~ 0.6 to 0.9 ns FWHM

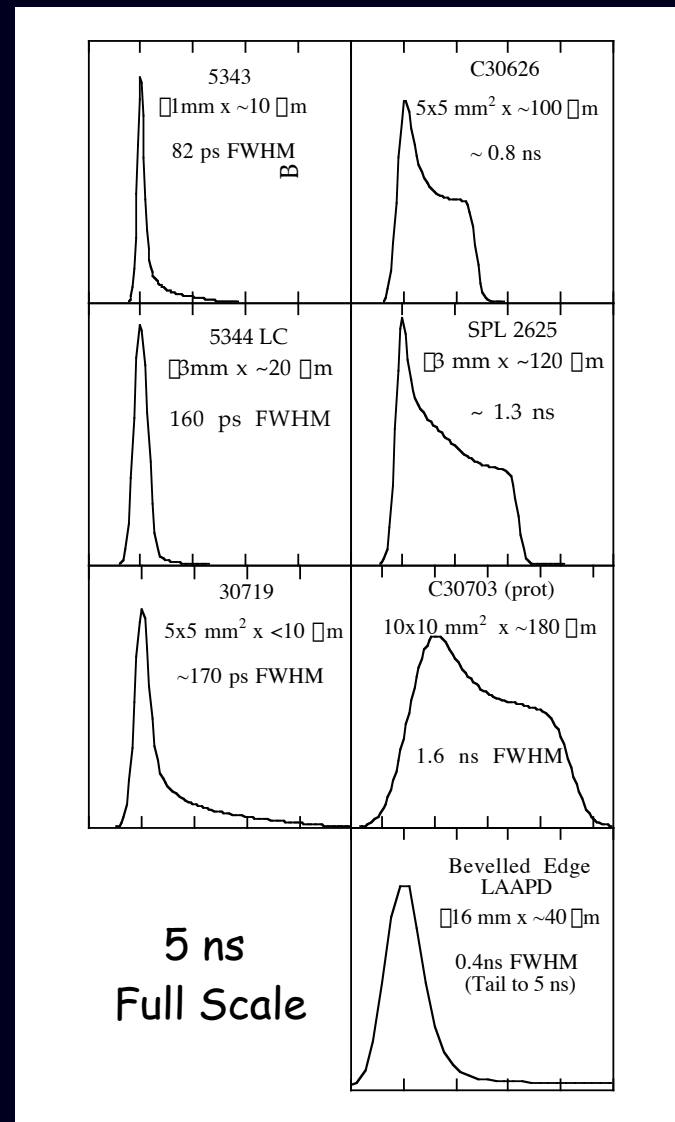


# X-Ray Time Resolution

As x-rays penetrate and tend to uniformly illuminate a device, the FWHM of the time resolution is mostly determined by the thickness of the drift region  
 ~ 10 ps/um near saturation

Tails determined by the field profiles near the surface

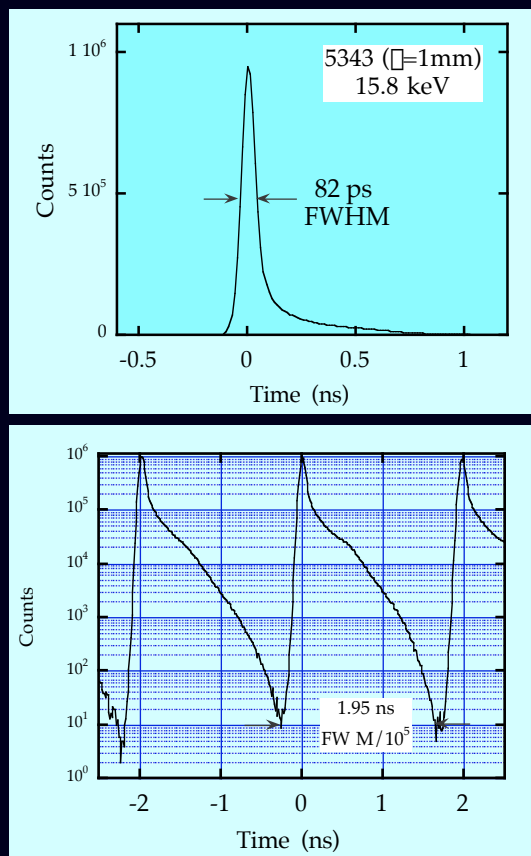
Note use of leading edge discriminator.





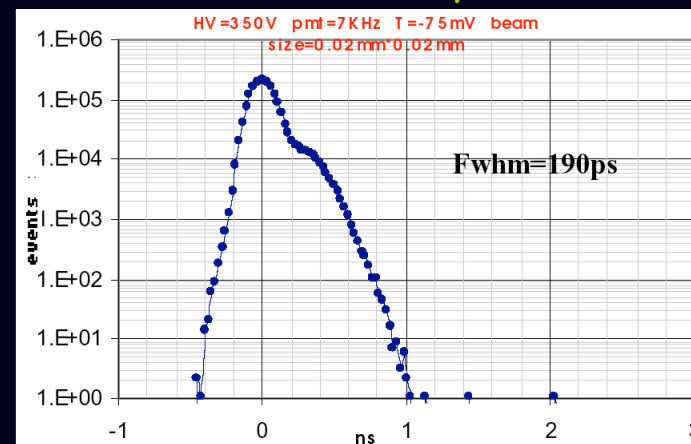
# Best Time Resolution

Best FWHM: 75 ps  
 ~ 10 um Device, Hamamatsu



Good Tail: < 2 ns at 1/10<sup>5</sup>

Best Tail: ~1.4 ns at 1/10<sup>5</sup>  
 ~30 um Device, PKI



(Work in progress, Deschaux, et al)

Note: Geiger Mode operation of small area devices has shown ~20 to 30 ps nominal resolution (Cova, Lacaita)

# Fast Counting

## Simplest "Non-Paralyzable" Model

$$n = \frac{m}{1 - mT}$$

$n$  = True Rate,  $m$  = Measured Rate

$T$  = System Dead Time

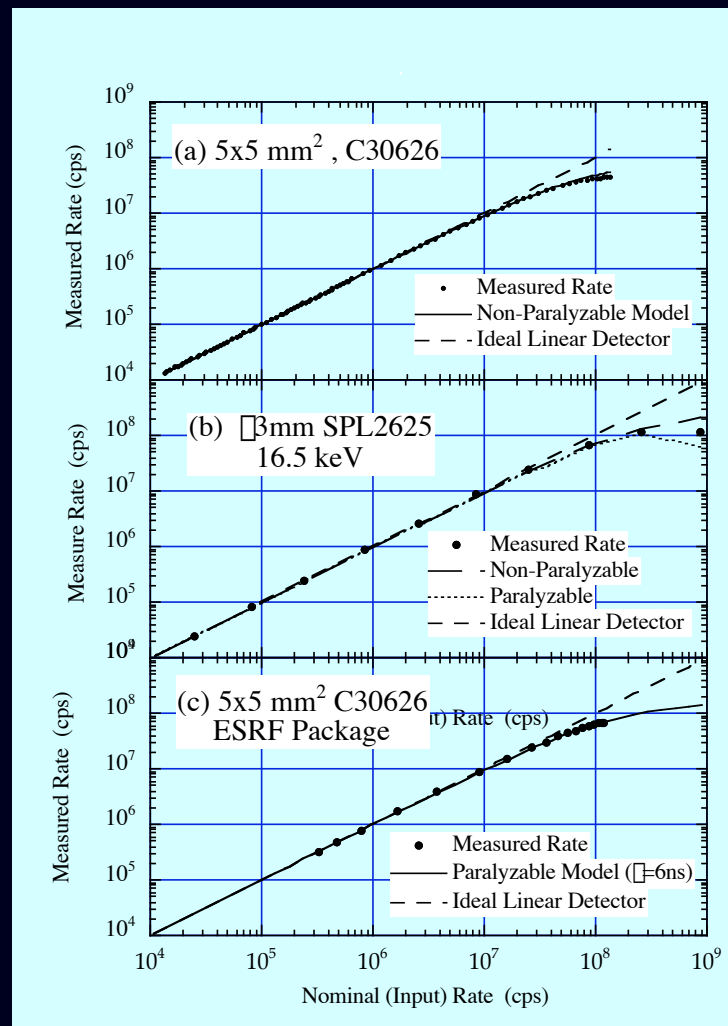
$T = 3$  to  $20$  ns

Source + APD + Discriminator + Counter

$mT = 0.1$  (20 MHz for  $T=5$  ns)

-> Can correct to ~1%

For  $mT > 0.1$  -> MUST Calibrate!



# Pulse Height Distribution

(X-Rays and Fast Electronics)

## Contributions:

Amplifier Noise

APD Gain Noise

Penetration into gain region

Typically 20-30% for thicker devices.

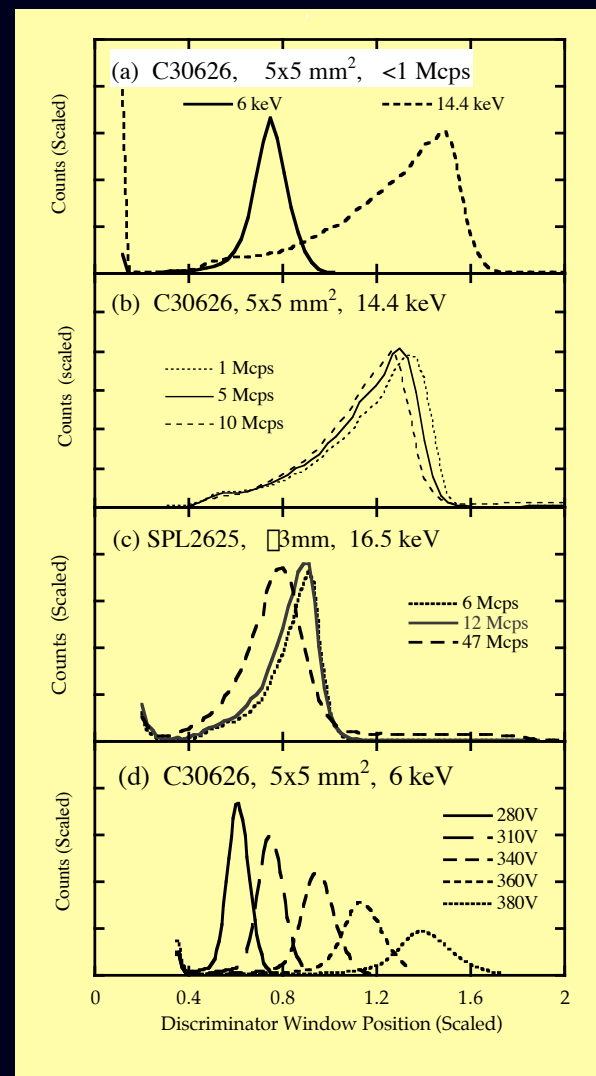
Base-line shift at high rates (AC-Coupling).

Better for lower capacitance devices.

Note: Slow Electronics, Low Gains,  
Cooling (-20C)

-> resolution ~5% possible

(Kishimoto)





# Other Points

Low T operation is possible - increased gain and T-sensitivity

~ 40K with API Beveled Edge (Yang)

~ 100K with Ham. Rev. APD (Dorokhov)

Electron Detection is possible - note radiation damage!

Hamamatsu Devices with special surface (Kishimoto)

With Gain - VAPD (Kushman)

Progress toward a more realistic PMT replacement?

Many ( $10^3/\text{mm}^2$ ) Geiger mode devices to keep

dynamic range & high gain (Buzhan, Sadygov)

(Next Talk, Otte and poster/ abs 126: Yokoyama)

# APD Arrays

Company	Device Structure	Type	Array Pixels	Pixel Size	Dead Space (mm)	Reference
Perkin-Elmer (PKI /EG&G)	C30985 (a)	M	1 x 25	~0.4 mm x 0.3 mm pitch	~0.07	Webb & McIntyre, 1984
	(a)	M	1 x 32	0.35 mm x 0.15 mm pitch	~0.05	Trakalo, <i>et al.</i> , 1987
	(a)	M	1 x 128	2 mm x 0.15 mm pitch	~0.05	Webb & Dion, 1991
Hamamatsu	S238X	M	1 x 16	$\phi 1$ or 1 x 1 mm <sup>2</sup>	0.1	Hara, <i>et al.</i> , 1996
	(b)	M	1 x 32	3.8 x 0.5 mm <sup>2</sup>	Var.	Nonaka, <i>et al.</i> , 1996
	S534X LC	M	1 x 16	2.5 x 1 mm <sup>2</sup>	0.1	Baron, <i>et al.</i> , 2004
	SPL2625	A	2 x 16 & 2 x 4	3 x 5 mm <sup>2</sup>	1	Kishimoto, <i>et al.</i> , 2004
	50 $\mu$ m (c) S5343 LC	M R	2 x 4 1 x 10	1 x 0.5 mm <sup>2</sup> $\phi 3$	0.1 3 or 0.1	Kishimoto, <i>et al.</i> , 2004 This work.
Advanced Photonix, Inc. (API)	Bev. Edge Grooved	M	8 x 8	1.3 x 1.3 mm <sup>2</sup>	0	Gramsch, <i>et al.</i> , 1993
				0.5 x 0.5 mm <sup>2</sup>	0	Gramsch, <i>et al.</i> , 1994
Radiation Monitoring Devices (RMD)	Plan. Bev. Grooved	M	4 x 4	2.1 x 2.1 mm <sup>2</sup>	0.4	Farrell, <i>et al.</i> , 2000
			8 x 8	13 x 13 mm <sup>2</sup>	0.4	
	Plan. Bev. Grooved.	M	14 x 14	2 x 2 mm <sup>2</sup>	0.1	Shah, <i>et al.</i> , 2001
			1	14 x 14 mm <sup>2</sup>	0	Levine, <i>et al.</i> , 2004
Anger. (d)		(d)	(d)			

M=Monolithic A=Assembled R=Replaceable

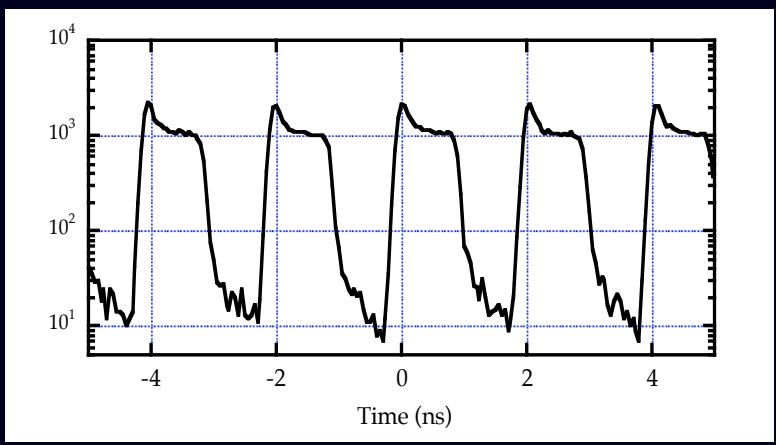
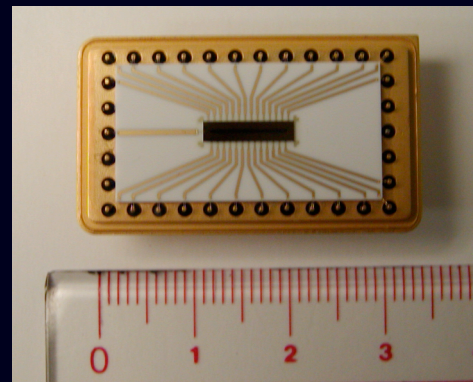
Note: Still relatively small numbers of pixels

# ns Linear Array

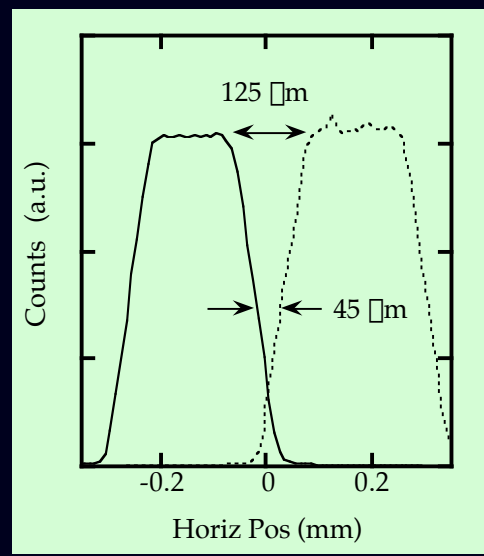
(Webb & McIntyre, 1984 - PKI C30985)

Linear Array, 25 elements, 0.3 mm pitch  
 ~ 100  $\mu$ m thick, ~1 ns resolution

Segmented cathode with bump bonding.



~1 ns resolution

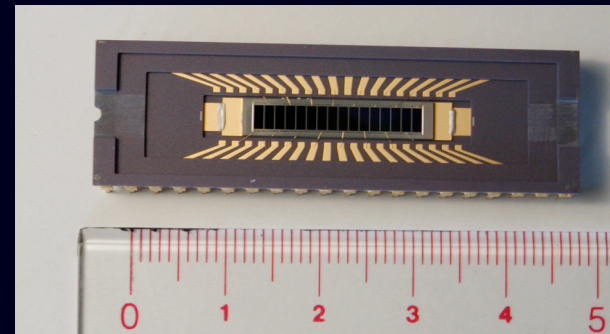


# Fast Linear Array

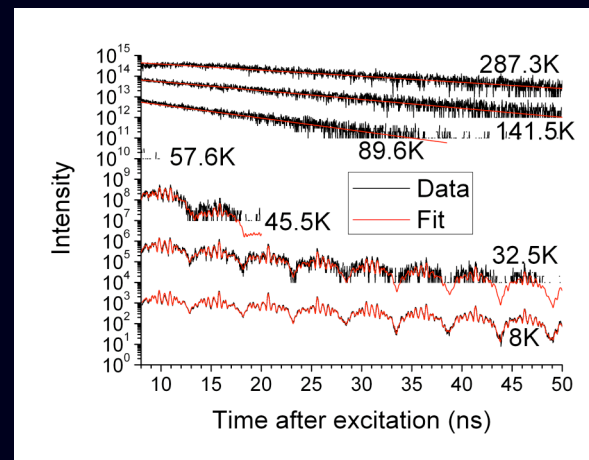
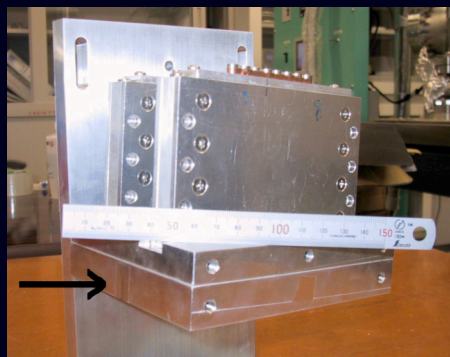
How can one keep good (200 ps) time resolution and high efficiency?

-> Grazing Incidence

16 Elements, 1.1 mm pitch  
 $1 \times 2.5 \text{ mm}^2 \times 20 \text{ um}$  thick



2 Degree grazing angle ->  $0.6 \times 2.5 \text{ mm}$  Acceptance, 0.6 mm Thick  
 Efficiency:  $\sim 1\% \rightarrow 17\%$



Magnetic Relaxation in Spin-Ice (Sutter et al)

Note: Device stability is an issue.

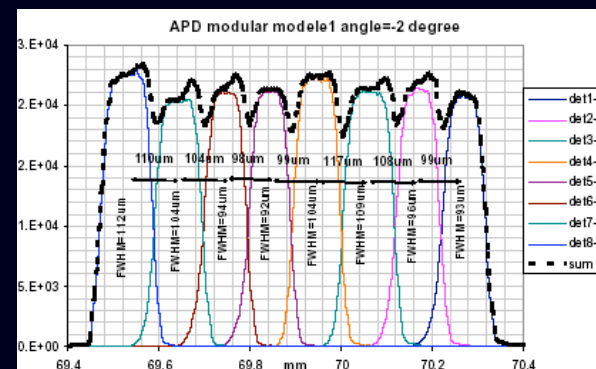
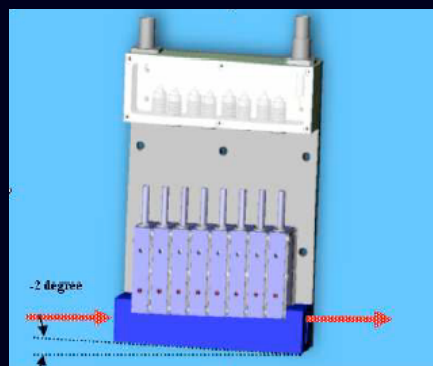
# Modular Array

Now Under Construction - SPRING-8 - ESRF Collaboration

Similar concept to the "Fast Array"

Grazing incidence gets you good (200 ps) time resolution  
and good x-ray stopping power

But Modular: Element replacement possible.  
Amplifier design simplified.



8 Elements,  $3\text{mm} \times 20\text{um}$ , incline at 2 degrees  $\rightarrow \sim 0.8 \times 2.0\text{mm}^2 \times 0.6\text{mm}$  thick



# The Next Step: Integration

Discussion/Collaboration:

ESRF, APS, SPring-8, DESY, KEK, &..

First Goal (?): Fast (us) framing detector.

A Properly Instrumented APD Array

Pixel Size:  $\sim 0.3 \times 0.3 \text{ mm}^2 \times 0.2 \text{ mm}$  thick

(Efficient and  $\sim 2 \text{ ns}$  time resolution)

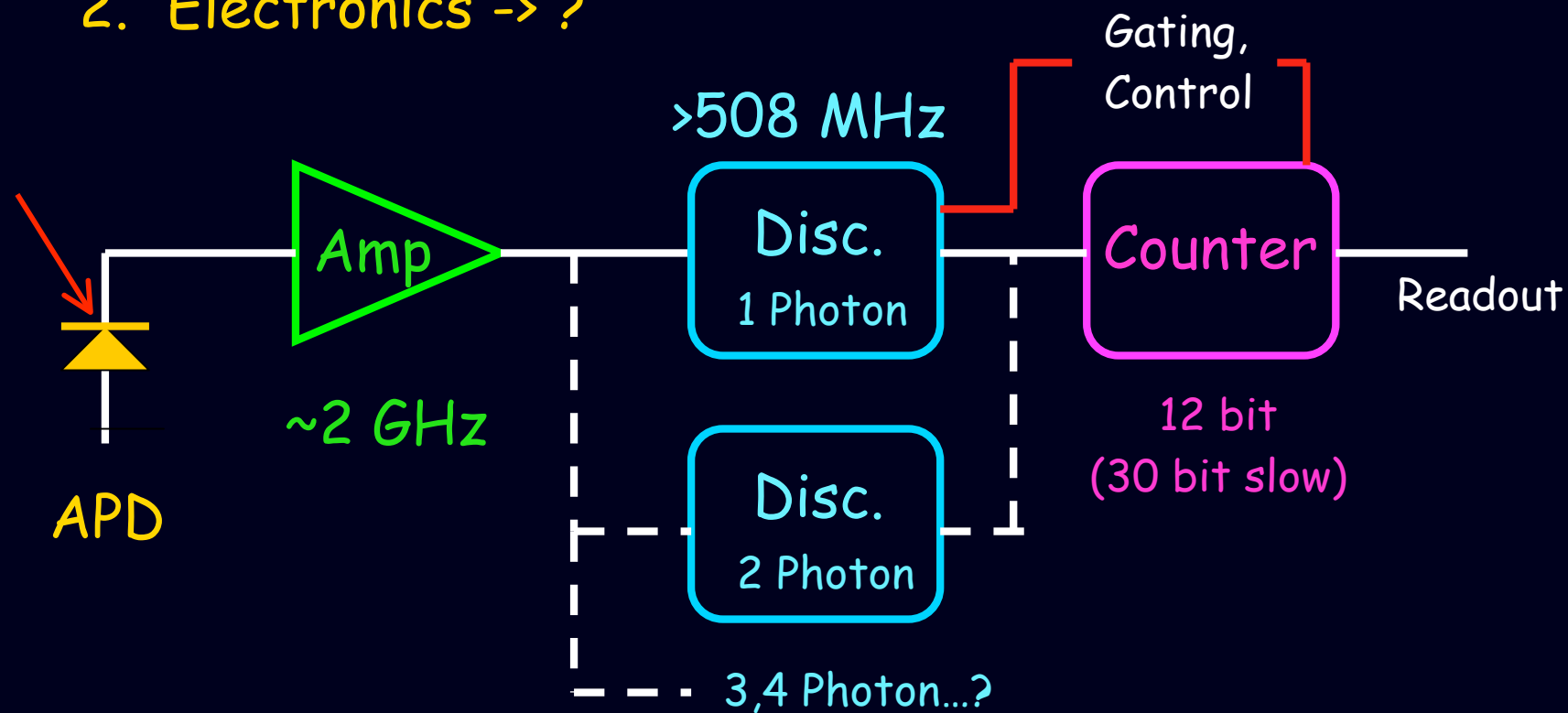
$\sim 10^3$  channels ( $1 \text{ cm}^2$ ) at first  $\rightarrow 10^5$

Utility: Fast imaging, Stroboscopic Measurements, XPCS  
 With different electronics, NRS: NSAXS, SRPAC



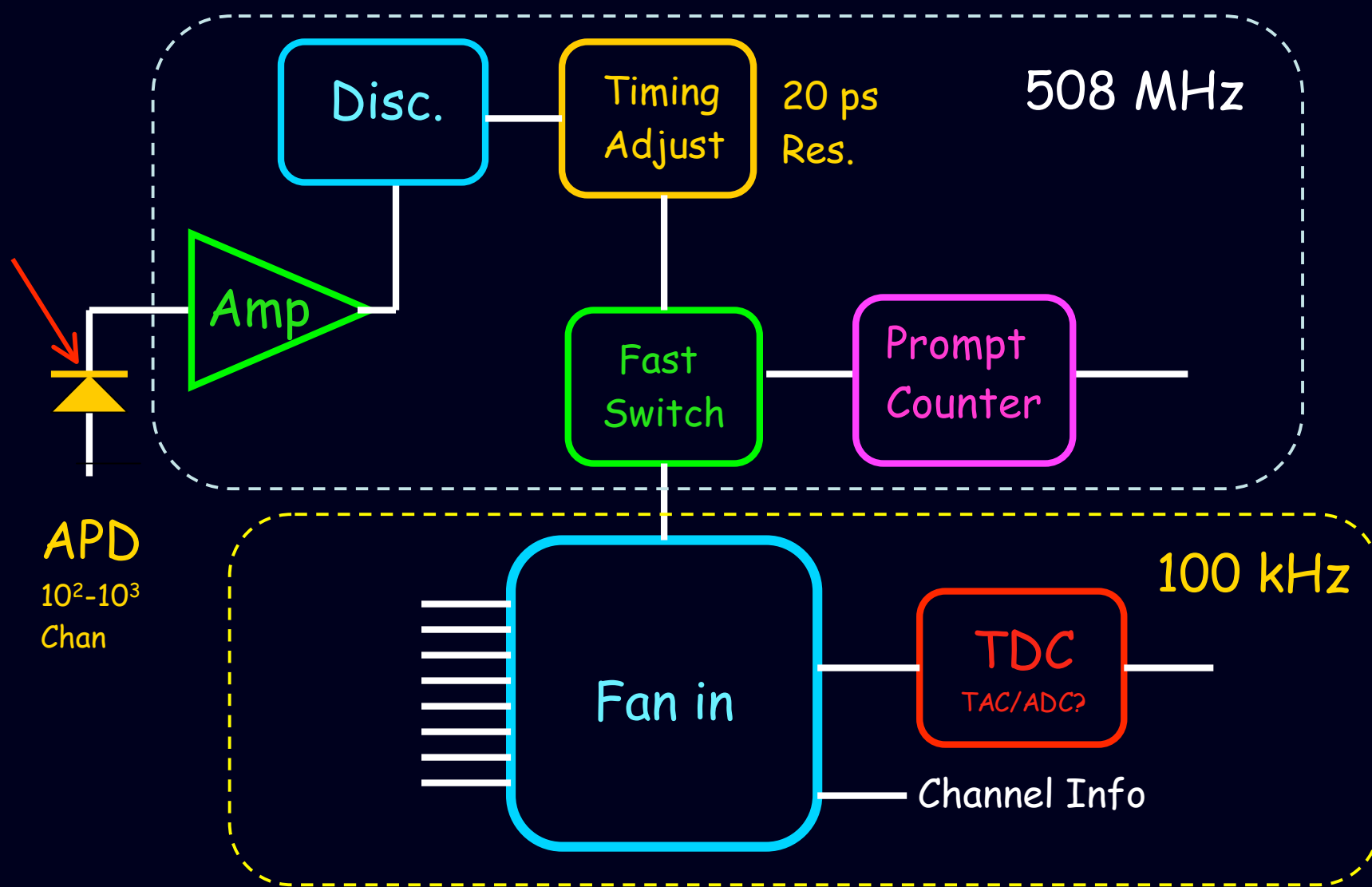
# Fast Framing Detector

1. The Array Device -> Not so hard.
2. Electronics -> ?



Question: On board histogramming for stroboscopic work?

# Modified Electronic for NRS



# APD Collaborators

KEK: S. Kishimoto

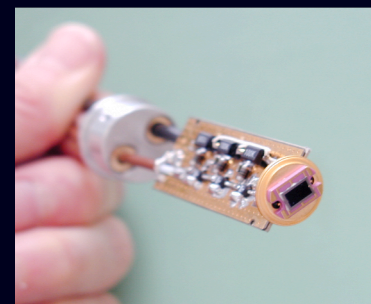
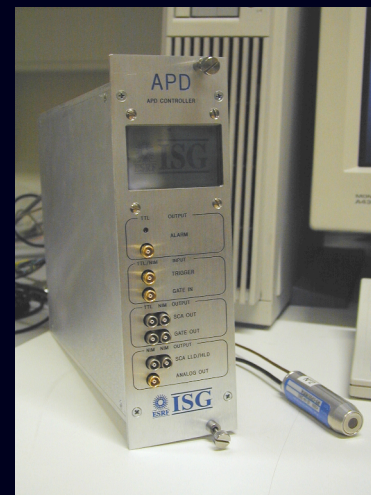
ESRF: T. Deschaux, R. Rüffer

SPring-8: T. Ishikawa (& T. Kudo)

# Packaged Fast Counting Systems

BNL

Kuczewski, Siddons



ESRF

Rigal, Morse, et al.